11160 to 11970 MHz 50Ω

- The Big Deal
 •Small size 3.2mm x 1.6mm
- •Pass band (11000-12000 MHz)
- •Very high rejection over wide band



Product Overview

The BFCN-1152+ LTCC Band Pass Filter achieves a miniature size and high repeatability of performance. Wrap-around terminations minimize variations in performance due to parasitics. Covering 11160 to 11970 MHz, these units offer excellent rejection over a wide stopband.

Key Features

Feature	Advantages
Small Size (3.20mm x1.6 mm)	Allows for high layout density of circuit boards, while minimizing effects of parasitics.
Rejection peaks close to pass band	Provides good rejection of signals close to the pass band, for improved system performance.
Wide stopband	No regrowth at 2nd harmonic permits filter to be used in presence of wideband undesired signals.
LTCC construction	Provides a rugged package that is well suited for tough environments including high humidity and high temperature extremes.

Ceramic

Bandpass Filter

50Ω 11160 to 11970 MHz

Features

- Small size
- Temperature stable
- · Hermetically sealed
- LTCC construction

Applications

- Harmonic Rejection
- Transmitters / Receivers

Specification Definition OD OD F3 F1 F2 F4 F5 FREQUENCY (MHz)

BFCN-1152+



Generic photo used for illustration purposes only CASE STYLE: FV1206-9

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



Electrical Specifications(1,2) at 25°C

Parameter		F#	Frequency (MHz)	Min.	Тур.	Max.	Unit
	Center Frequency	_	_	_	11540	_	MHz
Pass Band	Insertion Loss	F1-F2	11160-11970	_	5.0	7	dB
	VSWR		11160-11970	_	1.65	_	:1
	Insertion Loss		11200-11400		4	_	dB
Cton Bond Lawer	Insertion Loss	DC-F3	DC-8950	35	50	_	dB
Stop Band, Lower	VSWR	DC-F3	DC-8950	_	20	_	:1
Insertion Loss		F4-F5	13750-20900	25	35	_	dB
Stop Band, Upper	IIISEI IIOII LOSS	F5-F6	20900-38000	15	25	_	dB
	VSWR	F4-F6	13750-38000	_	10	_	:1

Measured on Mini-Circuits Characterization Test Board TB-1003+ with feedline losses removed by normalization of S12 and S21 traces to measurement of TB thru-line.

Maximum Ratings

Operating Temperature	-55°C to +100°C
Storage Temperature	-55°C to +100°C
RF Power Input*	2W at 25°C

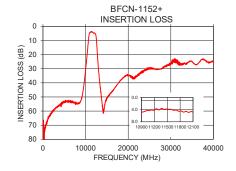
^{*}Passband rating, derate linearly to 0.5W at 100°C ambient Permanent damage may occur if any of these limits are exceeded.

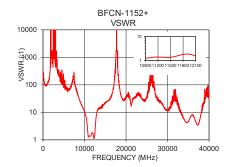
Typical Performance Data at 25°C

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)
1000	67.38	108.58
5000	54.08	86.86
9000	51.69	23.49
10000	31.18	10.56
10600	12.50	4.02
10800	6.48	1.79
11550	3.91	1.41
11800	4.50	1.79
12600	11.62	2.99
13000	29.17	10.37
17000	42.95	82.73
25000	30.09	36.20
32000	25.63	42.38
36000	27.21	8.23
40000	23.94	29.96

Pad Connections

Input	1
Output	3
Ground	2



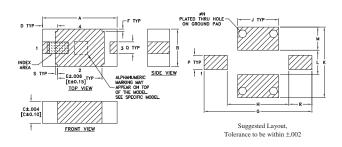




This filter is not intended for use as a DC Blocking circuit element. In Application where DC voltage is present at either input or output ports, blocking capacitors are required at the corresponding RF port.

BFCN-1152+

Outline Drawing



Pad Connections

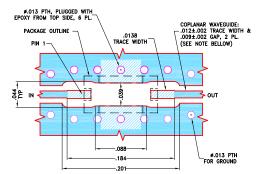
Input	1
Output	3
Ground	2

Product Marking: JP

Outline Dimensions (inch)

Α	В	С	D	Е	F	G	Н	J
.126	.063	.037	.026	.075	.004	.182	.104	.069
3.20	1.60	0.94	0.66	1.91	0.10	4.62	2.64	1.753
K	L	M	N	Р	Q	R	S	wt
	L 0.041						_	

Demo Board MCL P/N: TB- 1003+ Suggested PCB Layout (PL-610)



- NOIES:

 1. TRACE WIDTH AND GAP PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS. JOG6⁵²-LOOO7⁵. COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.

 2. BOITOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

 3. UNIT LAND PATTERN WAS OPTIMIZED FOR BETTER PERFORMANCE.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER). DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

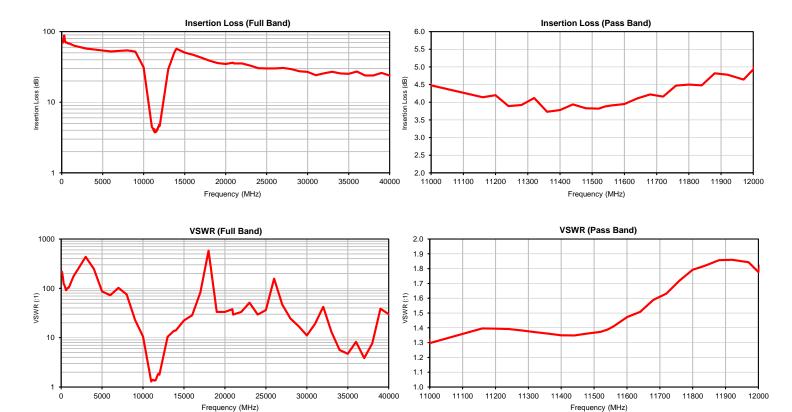


	VSWR
(dB)	(:1)
	217.15
69.76	102.19
67.38	108.58
63.18	173.72
57.45	434.30
55.90	248.17
	86.86
	72.39 102.19
	75.53
52.29	25.19
51.69	23.49
31.18	10.56
	1.30
	1.40
	1.39 1.39
3.92	1.38
4.12	1.37
3.73	1.36
3.78	1.35
3.94	1.35
	1.36
	1.37
	1.39 1.41
	1.47
4.11	1.51
4.22	1.59
4.16	1.63
	1.72
	1.79 1.82
	1.86
	1.86
4.64	1.84
4.93	1.78
29.17	10.37
	13.70
	14.03 22.29
	28.49
42.95	82.73
38.77	579.06
35.89	33.42
34.82	33.42
	37.77
	29.46 33.42
33.02	51.10
30.37	29.46
30.09	36.20
30.08	157.93
30.58	46.96
29.46	24.48
	17.05 11.09
	19.11
25.63	42.38
27.00	13.09
25.56	5.63
25.25	4.72
27.21	8.23
	3.86
	7.66 38.61
	29.96
	69.17 69.76 67.38 63.18 57.45 55.90 54.08 52.35 53.21 54.28 52.29 51.69 31.18 4.48 4.14 4.20 3.89 3.92 4.12 3.73 3.78 3.94 3.83 3.91 3.95 4.11 4.22 4.16 4.47 4.50 4.48 4.82 4.78 4.64 4.93 29.17 50.98 57.30 50.50 47.00 42.95 38.77 35.89 33.02 30.37 30.09 30.08 30.58 29.46 27.40 26.85 24.08 25.63 27.00 25.56 25.25





Typical Performance Curves





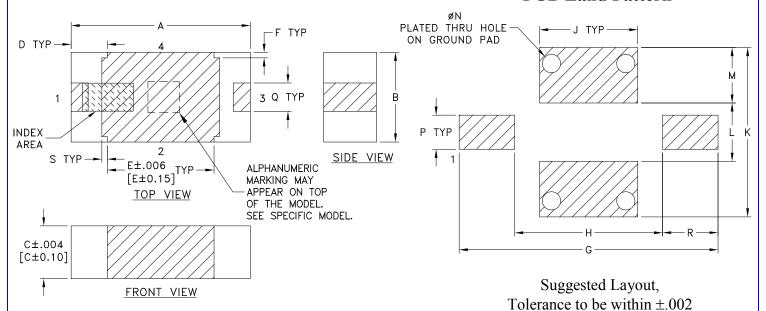
Case Style



FV1206-9

Outline Dimensions

PCB Land Pattern



CASE #	A	В	С	D	Е	F	G	Н	J	K	L	M
FV1206-9	.126	.063	.037	.026	.075	.004	.182	.104	.069	.119	.041	.039
	(3.20)	(1.60)	(0.94)	(0.66)	(1.91)	(0.10)	(4.62)	(2.64)	(1.75)	(3.02)	(1.04)	(0.99)

CASE#	N	P	Q	R	S	WT. GRAM
FV1206-9	.013 (0.33)	.024 (0.61)	.020 (0.51)	.039 (0.99)	.004 (0.10)	.020

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

- 1. Open style, ceramic base.
- 2. Termination finish: as shown below or indicated on Data Sheet.

For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



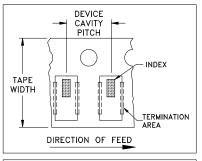


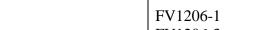
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

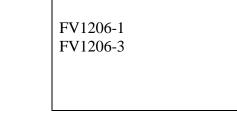
The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging







Applicable Case Styles

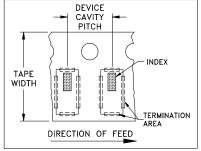
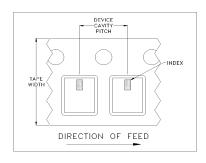


ILLUSTRATION 2

ILLUSTRATION 1

Applicable Case Styles	
FV1206-4	
FV1206-5	
FV1206-6	
FV1206-7	
FV1206-9	



Applicable Case Styles
FV1206-11
FV1206-12
GE0805C-18
NL1008C-6
NL1008C-7
NL1008C-9
NL1008C-10
NL1008C-12

ILLUSTRATION 3

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices 1	oer Reel
0	4		Small quantity standards	20 50 100
8	4	7	(see note) Standard	200 500 1000 3000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



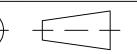
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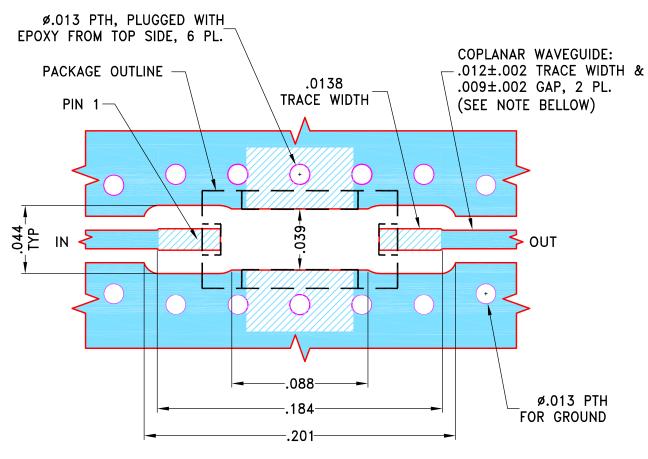
Mini-Circuits ISO 9001 & ISO 14001 Certified

THIRD ANGLE PROJECTION



		REVISIONS			
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M170506	NEW RELEASE	12/06/18	ITG	BK

SUGGESTED MOUNTING CONFIGURATION FOR FV1206-9 CASE STYLE, "04FL01" PIN CODE



NOTES:

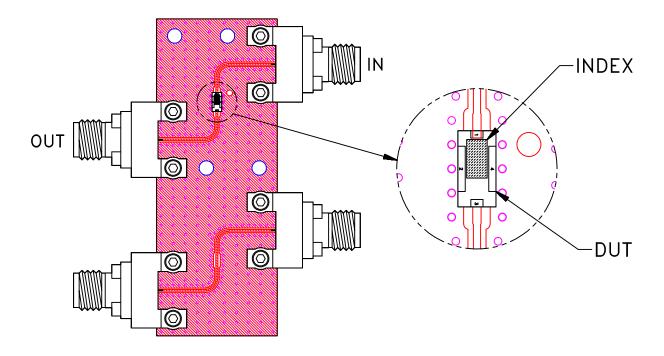
- 1. TRACE WIDTH AND GAP PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .0066"±.0007". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- 3. UNIT LAND PATTERN WAS OPTIMIZED FOR BETTER PERFORMANCE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

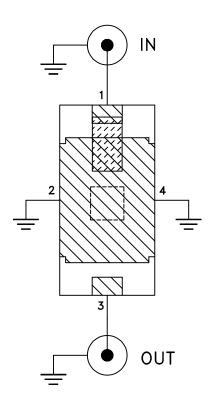
DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE	」		. ~	i	• 4 (R	0		
DIMENSIONS ARE IN INCHES	DRAWN	ITG	12/05/18		\square Min:	1 – C 1	ırcu	1ts	13 Neptu	ne Avenue	e
TOLERANCES ON: 2 PL DECIMALS ±	CHECKED	GF	12/05/18		Γ				Бгооктуп	NI IIZOO	,
3 PL DECIMALS ± .005 ANGLES ±	APPROVED	BK	12/06/18	1							
FRACTIONS ±] PL.	04FL0	1. FV	71206	-9.	TB-1	1003	+
□□□ Mini−Circuits ®],		-, - ·		-,			
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			FILE: C	8PL610	SCALE:	16:1	SHEET:	1	OF 1		
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Evaluation Board and Circuit



TB-1003+



Schematic Diagram

Notes:

- 1. 50 Ohm 2.92 mm Female connectors.
- 2. PCB Material: RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.0066 inch.





Environmental Specifications

ENV06

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec			
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet			
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet			
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours			
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1			
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage			
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D			
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A			

ENV06 Rev: A

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02/25/11

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